

HART Modem

A5191HRT

Description

The A5191HRT is a single-chip, CMOS modem for use in highway addressable remote transducer (HART) field instruments and masters. The modem and a few external passive components provide all of the functions needed to satisfy HART physical layer requirements including modulation, demodulation, receive filtering, carrier detect, and transmit-signal shaping.

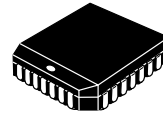
The A5191HRT uses phase continuous frequency shift keying (FSK) at 1200 bits per second. To conserve power the receive circuits are disabled during transmit operations and vice versa. This provides the half-duplex operation used in HART communications.

Features

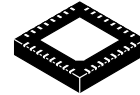
- Single-chip, Half-duplex 1200 Bits per Second FSK Modem
- Bell 202 Shift Frequencies of 1200 Hz and 2200 Hz
- 3.0 V – 5.5 V Power Supply
- Transmit-signal Wave Shaping
- Receive Band-pass Filter
- Low Power: Optimal for Intrinsically Safe Applications
- Compatible with 3.3 V or 5 V Microcontroller
- Internal Oscillator Requires 460.8 kHz Crystal or Ceramic Resonator
- Meets HART Physical Layer Requirements
- Industrial Temperature Range of –40 °C to +85 °C
- Available in 28-pin PLCC, 32-pin QFN and 32-pin LQFP Packages
- These are Pb-Free Devices

Applications

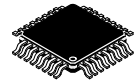
- HART Multiplexers
- HART Modem Interfaces
- 4 – 20 mA Loop Powered Transmitters



PLCC-28
P SUFFIX
CASE 776AA



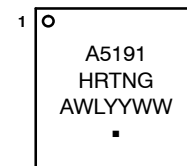
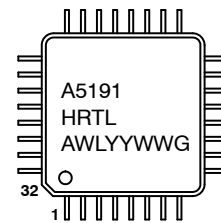
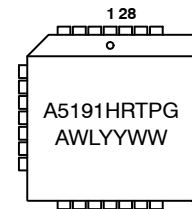
QFN-32
N SUFFIX
CASE 488AM



LQFP-32
L SUFFIX
CASE 561AB

MARKING DIAGRAMS

(Top Views)



A5191HRTxx = Specific Device Code
xx = P (PLCC), L (LQFP) or N (QFN)
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
G or ■ = Pb-Free Package

ORDERING INFORMATION

See detailed ordering and shipping information on page 11 of this data sheet.

NOTE: Some of the devices on this data sheet have been **DISCONTINUED**. Please refer to the table on page 11.

A5191HRT

BLOCK DIAGRAM

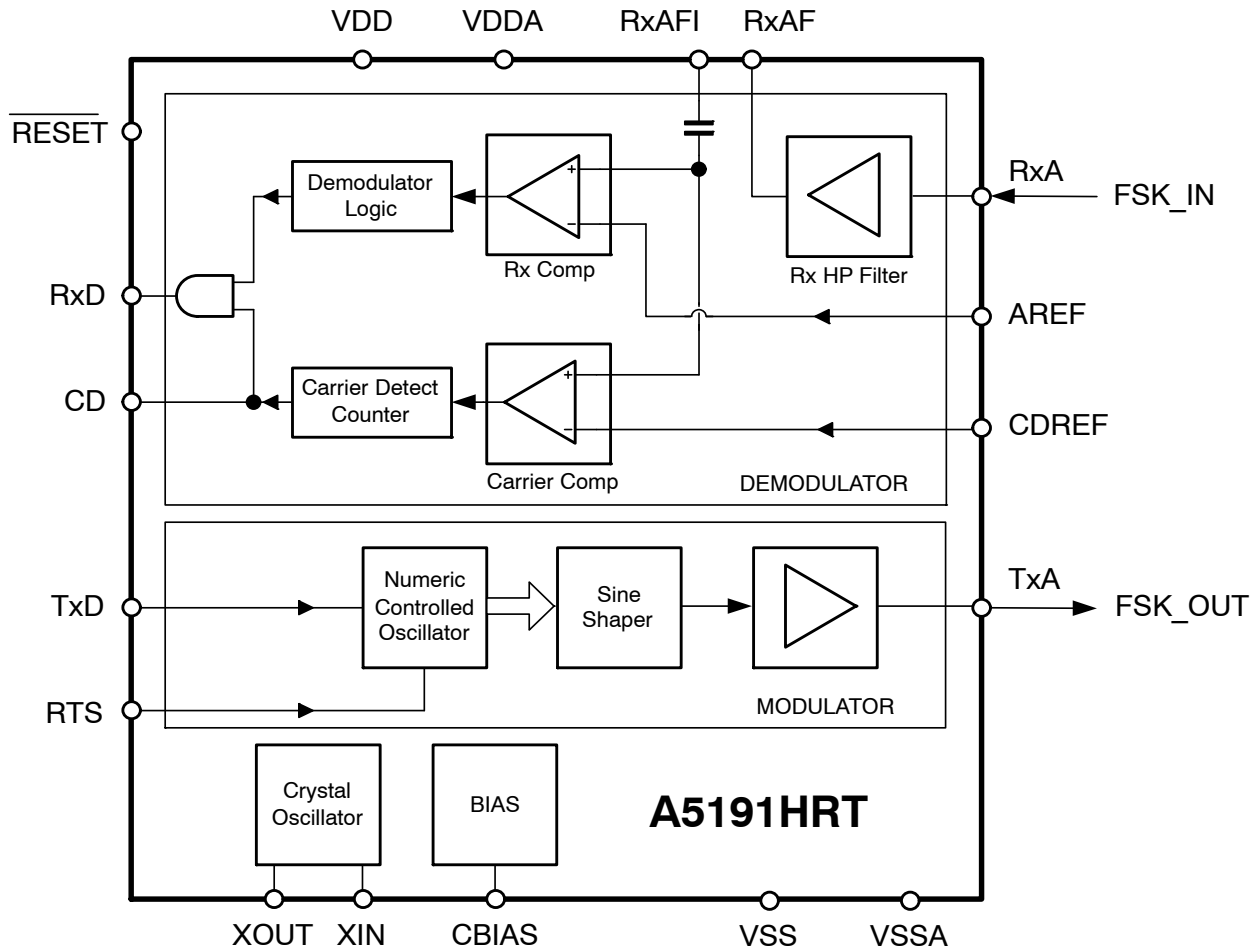


Figure 1. Block Diagram A5191HRT

ELECTRICAL SPECIFICATIONS

Table 1. ABSOLUTE MAXIMUM RATINGS (Notes 1 and 2)

Symbol	Parameter	Min	Max	Units
T_A	Ambient	-40	+85	°C
T_S	Storage Temperature	-55	+150	°C
T_J	Junction Temperature	-40	+85	°C
V_{DD}	Supply Voltage	-0.3	6.0	V
V_{IN}, V_{OUT}	DC Input, Output	-0.3	$V_{DD} + 0.3$	V

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- CMOS devices are damaged by high-energy electrostatic discharge. Devices must be stored in conductive foam or with all pins shunted. Precautions should be taken to avoid application of voltages higher than the maximum rating. Stresses above absolute maximum ratings may result in damage to the device.
- Remove power before insertion or removal of this device.

A5191HRT

Table 2. DC CHARACTERISTICS ($V_{DD} = 3.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$)

Symbol	Parameter	V_{DD}	Min	Typ	Max	Units
V_{IL}	Input Voltage, Low	3.0 – 5.5 V			$0.3 * V_{DD}$	V
V_{IH}	Input Voltage, High	3.0 – 5.5 V	$0.7 * V_{DD}$			V
V_{OL}	Output Voltage, Low ($I_{OL} = 0.67\text{ mA}$)	3.0 – 5.5 V			0.4	V
V_{OH}	Output Voltage, High ($I_{OH} = -0.67\text{ mA}$)	3.0 – 5.5 V	2.4			V
C_{IN}	Input Capacitance of: Analog Input RXA Digital Input			2.9 25 3.5		pF pF pF
I_{IL}/I_{IH}	Input Leakage Current				± 500	nA
I_{OLL}	Output Leakage Current				± 10	μA
I_{DDA}	Power Supply Current ($R_{BIAS} = 500\text{ k}\Omega$, $A_{REF} = 1.235\text{ V}$)	3.3 V 5.0 V	150 150	330 300	450 600	μA μA
I_{DDD}	Dynamic Digital Current	5.0 V	25		200	μA
A_{REF}	Analog Reference	3.3 V 5.0 V	1.2	1.235 2.5	2.6	V V
CD_{REF} (Note 3)	Carrier Detect Reference ($A_{REF} - 0.08\text{ V}$)	3.3 V 5.0 V		1.15 2.42		V
C_{BIAS}	Comparator Bias Current ($R_{BIAS} = 500\text{ k}\Omega$, $A_{REF} = 1.235\text{ V}$)			2.5		μA

3. The HART specification requires carrier detect (CD) to be active between 80 and 120 mVp-p. Setting CD_{REF} at $A_{REF} - 0.08\text{ VDC}$ will set the carrier detect to a nominal 100 mVp-p.

Table 3. AC CHARACTERISTICS ($V_{DD} = 3.0\text{ V to }5.5\text{ V}$, $V_{SS} = 0\text{ V}$, $T_A = -40\text{ }^{\circ}\text{C to }+85\text{ }^{\circ}\text{C}$) (Note 4)

Pin Name	Description	Min	Typ	Max	Units
RxA	Receive analog input Leakage current Frequency – mark (logic 1) Frequency – space (logic 0)	1190 2180	1200 2200	± 150 1210 2220	nA Hz Hz
RxAF	Output of the high-pass filter Slew rate Gain bandwidth (GBW) Voltage range	150 0.15	0.025	$V_{DD} - 0.15$	V/ μs kHz V
RxAFI	Carrier detect and receive filter input Leakage current			± 500	nA
TxA	Modulator output Frequency – mark (logic 1) Frequency – space (logic 0) Amplitude ($A_{REF} 1.235\text{ V}$) Slew Rate – mark (logic 1) Slew Rate – space (logic 0) Loading ($A_{REF} = 1.235\text{ V}$)	30	1196.9 2194.3 500 1860 3300		Hz Hz mV V/s V/s k Ω
RxD	Receive digital output Rise/fall time	20			ns
CD	Carrier detect output Rise/fall time	20			ns

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

4. The modular output frequencies are proportional to the input clock frequency (460.8 kHz).



A5191HRT

Table 4. MODEM CHARACTERISTICS ($V_{DD} = 3.0 \text{ V to } 5.5 \text{ V}$, $V_{SS} = 0 \text{ V}$, $T_A = -40^\circ \text{ C to } +85^\circ \text{ C}$)

Parameter	Min	Typ	Max	Units
Demodulator jitter Conditions 1. Input frequencies at $1200 \text{ Hz} \pm 10 \text{ Hz}$, $2200 \text{ Hz} \pm 20 \text{ Hz}$ 2. Clock frequency of $460.8 \text{ kHz} \pm 0.1\%$ 3. Input (RxA) asymmetry, 0			12	% of 1 bit

Table 5. CERAMIC RESONATOR – External Clock Specifications ($V_{DD} = 3.0 \text{ V to } 5.5 \text{ V}$, $V_{SS} = 0 \text{ V}$, $T_A = -40^\circ \text{ C to } +85^\circ \text{ C}$)

Parameter	Min	Typ	Max	Units
Resonator Tolerance Frequency		460.8	1.0	% kHz
External Clock frequency Duty cycle Amplitude	456.2 40	460.8 50 $V_{OH} - V_{OL}$	465.4 60	kHz % V

TYPICAL APPLICATION

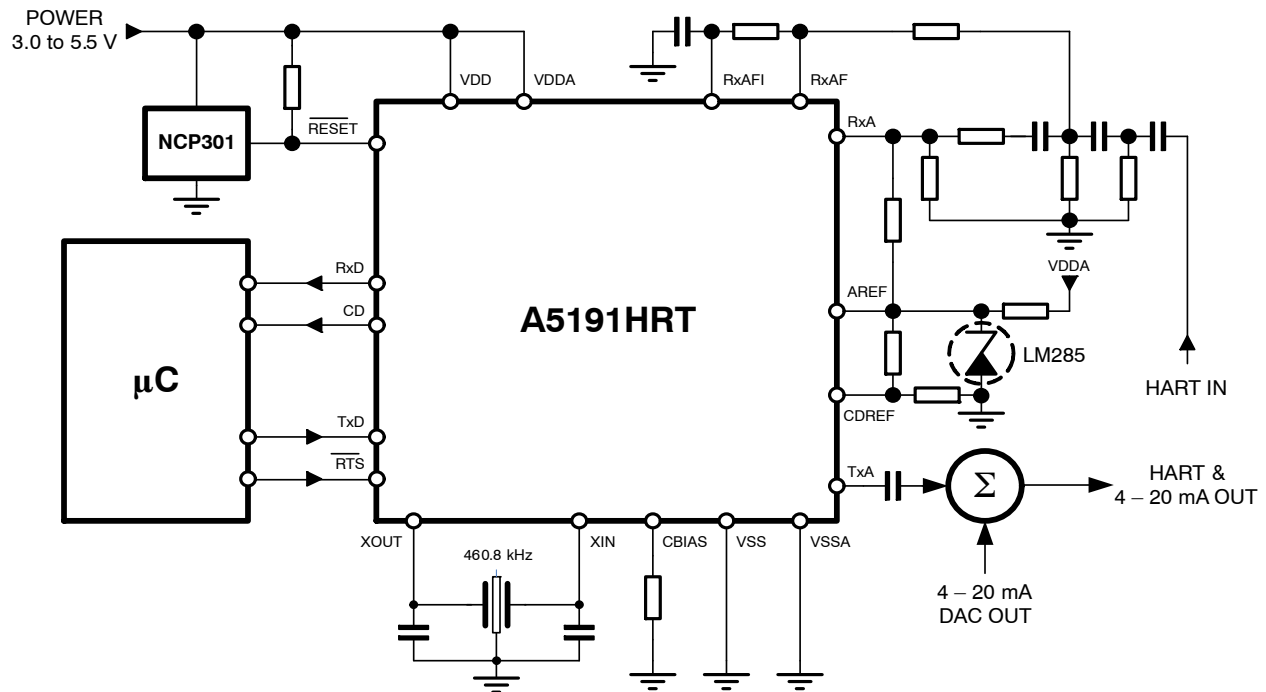


Figure 2. Application Diagram A5191HRT

A5191HRT

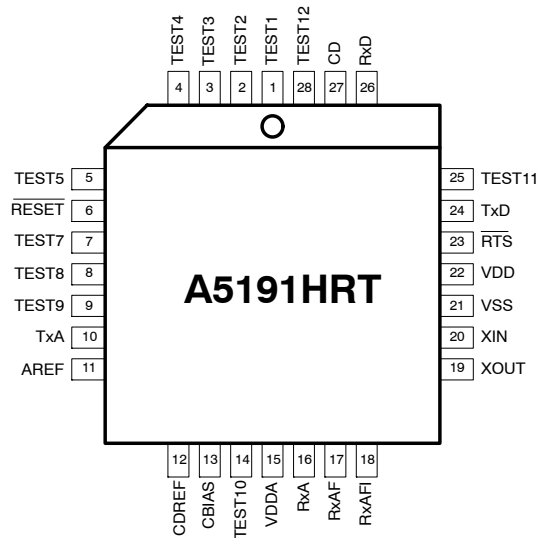


Figure 3. Pin Out A5191HRT in 28-pin PLCC

Table 6. PIN OUT SUMMARY 28-PIN PLCC

Pin No.	Signal Name	Type	Pin Description
1	TEST1	Input	Connect to VSS
2, 3, 4	TEST2, 3, 4	–	Do Not Connect
5	TEST5	Input	Connect to VSS
6	RESETB	Input	Reset all digital logic when low
7, 8, 9	TEST7, 8, 9	Input	Connect to VSS
10	TxA	Output	Transmit Data Modulator output
11	AREF	Input	Analog reference voltage
12	CDREF	Input	Carrier detect reference voltage
13	CBIAS	Output	Comparator bias current
14	TEST10	Input	Connect to VSS
15	VDDA	Power	Analog supply voltage
16	RxA	Input	Receive Data Modulator input
17	RxAF	Output	Analog receive filter output
18	RxAFI	Input	Analog receive comparator input
19	XOUT	Output	Crystal oscillator output
20	XIN	Input	Crystal oscillator input
21	VSS	Ground	Ground
22	VDD	Power	Digital supply voltage
23	RTSB	Input	Request to send
24	TxD	Input	Input transmit date, transmitted HART data stream from microcontroller
25	TEST11	–	Do Not Connect
26	RxD	Output	Received demodulated HART data to microcontroller
27	CD	Output	Carrier detect output
28	TEST12	–	Do Not Connect

A5191HRT

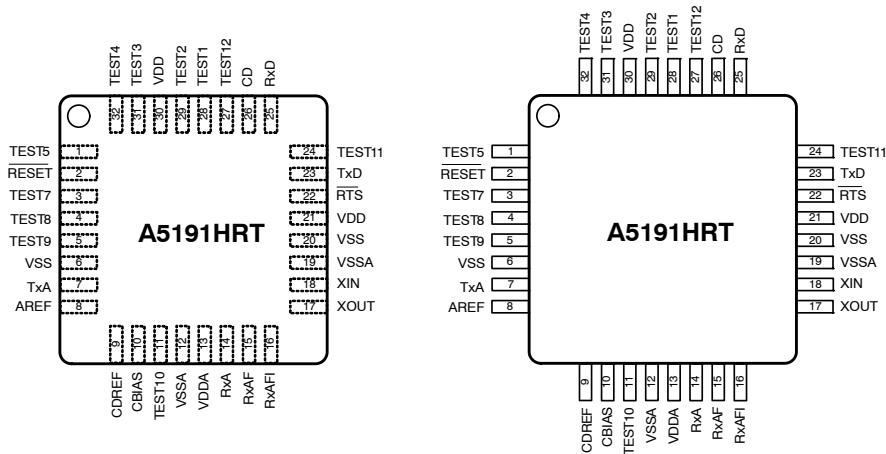


Figure 4. Pin Out A5191HRT in 32-pin QFN and LQFP (top view)

Table 7. PIN OUT SUMMARY 32-PIN QFN AND LQFP

Pin No.	Signal Name	Type	Pin Description
1	TEST5	Input	Connect to VSS
2	RESETB	Input	Reset all logic when low, connect to VDD for normal operation
3, 4, 5	TEST7, 8, 9	Input	Connect to VSS
6	VSS	Ground	Digital ground
7	TxA	Output	Transmit Data Modulator output
8	AREF	Input	Analog reference voltage
9	CDREF	Input	Carrier detect reference voltage
10	CBIAS	Output	Comparator bias current
11	TEST10	Input	Connect to VSS
12	VSSA	Ground	Analog ground
13	VDDA	Power	Analog supply voltage
14	RxA	Input	Receive Data Modulator input
15	RxAF	Output	Analog receive filter output
16	RxAfI	Input	Analog receive comparator input
17	XOUT	Output	Crystal oscillator output
18	XIN	Input	Crystal oscillator input
19	VSSA	Ground	Analog ground
20	VSS	Ground	Digital ground
21	VDD	Power	Digital supply voltage
22	RTSB	Input	Request to send
23	TxD	Input	Input transmit data, transmit HART data stream from microcontroller
24	TEST11	-	Do Not Connect
25	RxD	Output	Received demodulated HART data to microcontroller
26	CD	Output	Carrier detect output
27	TEST12	-	Do Not Connect
28	TEST1	Input	Connect to VSS
29	TEST2	-	Do Not Connect
30	VDD	Power	Digital supply voltage
31, 32	TEST3, 4	-	Do Not Connect
EP	Exposed Pad	Power	Connect to VSS (QFN only)

Pin Descriptions

Table 8. PIN DESCRIPTIONS

Symbol	Pin Name	Description
AREF	Analog reference voltage	Receiver Reference Voltage. Normally 1.23 V is selected (in combination with VD-DA = 3.3 V). See Table 2.
CDREF	Carrier detect reference voltage	Carrier Detect Reference voltage. The value should be 85 mV below AREF to set the carrier detection to a nominal of 100 mV _{p-p} .
RESETB	Reset digital logic	When at logic low (V _{SS}) this input holds all the digital logic in reset. During normal operation RESETB should be at V _{DD} . RESETB should be held low for a minimum of 10 nS after V _{DD} = 2.5 V as shown in Figure 14.
RTSB	Request to send	Active-low input selects the operation of the modulator. TxA is enabled when this signal is low. This signal must be held high during power-up.
RxA	Analog receive input	Receive Data Demodulator Input. Accepts a HART 1200 / 2200 Hz FSK modulated waveform input.
RxAFI	Analog receive comparator input	Positive input of the carrier detect comparator and the receiver filter comparator.
TxD	Digital transmit input	Input to the modulator accepts digital data in NRZ form. When TxD is low, the modulator output frequency is 2200 Hz. When TxD is high, the modulator output frequency is 1200 Hz.
XIN	Oscillator input	Input to the internal oscillator must be connected to a parallel mode 460.8 kHz ceramic resonator when using the internal oscillator or grounded when using an external 460.8 kHz clock signal.
CBIAS	Comparator bias current	Connection to the external bias resistor. R _{BIAS} should be selected such that AREF / R _{BIAS} = 2.5 μ A $\pm$ 5 %
CD	Carrier detect output	Output goes high when a valid input is recognized on RxA. If the received signal is greater than the threshold specified on CDREF for four cycles of the RxA signal, the valid input is recognized.
RxAF	Analog receive filter output	The output of the three pole high pass receive data filter
RxD	Digital receive output	Signal outputs the digital receive data. When the received signal (RxA) is 1200 Hz, RxD outputs logic high. When the received signal (RxA) is 2200 Hz, RxD outputs logic low. The HART receive data stream is only active if Carrier Detect (CD) is high.
TxA	Analog transmit output	Transmit Data Modulator Output. A trapezoidal shaped waveform with a frequency of 1200 Hz or 2200 Hz corresponding to a data value of 1 or 0 respectively applied to TxD. TxA is active when RTSB is low. TxA equals 0.5 V when RTSB is high.
XOUT	Oscillator output	Output from the internal oscillator must be connected to an external 460.8 kHz clock signal or to a parallel mode 460.8 kHz ceramic resonator when using the internal oscillator.
TEST(12:1)	Factory test	Factory test pins; for normal operation, tie these signals as per Tables 6 and 7
VDD	Digital power	Power for the digital modem circuitry
VDDA	Analog supply voltage	Power for the analog modem circuitry
VSS	Ground	Digital ground (and Analog ground in the case of PLCC package)
VSSA	Analog ground	Analog ground

FUNCTIONAL DESCRIPTION

The A5191HRT is a single-chip modem for use in Highway Addressable Remote Transducer (HART) field instruments and masters. The modem IC contains a transmit data modulator with signal shaper, carrier detect circuitry, an analog receiver, demodulator circuitry and a crystal oscillator, as shown in the block diagram in Figure 1.

The modulator accepts digital data at its digital input TxD and generates a sine shaped FSK modulated signal at the analog output TxA. A digital "1" or mark is represented with a frequency of 1200 Hz. A digital "0" or space is represented with a frequency of 2200 Hz. The used bit rate is 1200 baud.

The demodulator receives the FSK signal at its analog input, filters it with a band-pass filter and generates 2 digital signals: RxD: Received Data and CD: Carrier Detect. At the digital output RxD the original modulated signal is received. CD outputs the Carrier Detect signal. It goes logic high if the received signal is above 100 mVpp during 4 consecutive carrier periods.

The oscillator provides the modem with a stable time base using either a simple external resonator or an external clock source.

DETAILED DESCRIPTION

Modulator

The modulator accepts digital data in NRZ form at the TxD input and generates the FSK modulated signal at the TxA output.

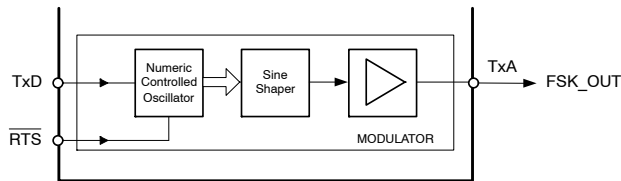


Figure 5. Modulator Block Diagram

A logic "1" or mark is represented by a frequency $f_m = 1200$ Hz. A logic "0" or space is represented by a frequency $f_s = 2200$ Hz.

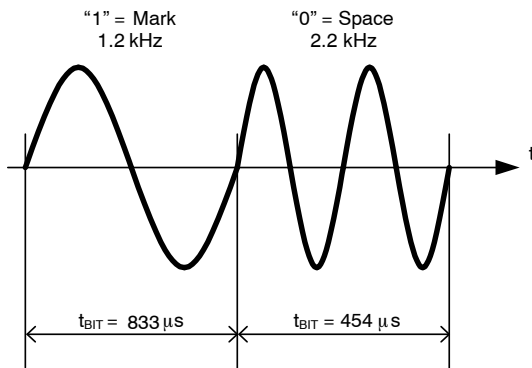


Figure 6. Modulation Timing

The Numeric Controlled Oscillator NCO works in a phase continuous mode preventing abrupt phase shifts when switching between mark and space frequency. The control signal Request To Send RTSB enables the NCO. When RTSB is logic low the modulator is active and A5191HRT is in transmit mode. When RTSB is logic high the modulator is disabled and A5191HRT is in receive mode.

The digital outputs of the NCO are shaped in the Wave Shaper block to a trapezoidal signal. This circuit controls the rising and falling edge to be inside the standard HART waveshape limits. Figure 7 shows the transmit-signal forms captured at TxA for mark and space frequency. The slew rates are $SR_m = 1860$ V/s at the mark frequency and $SR_s = 3300$ V/s at the space frequency. For $A_{REF} = 1.235$ V, TxA will have a voltage swing from approximately 0.25 to 0.75 V_{DC} .

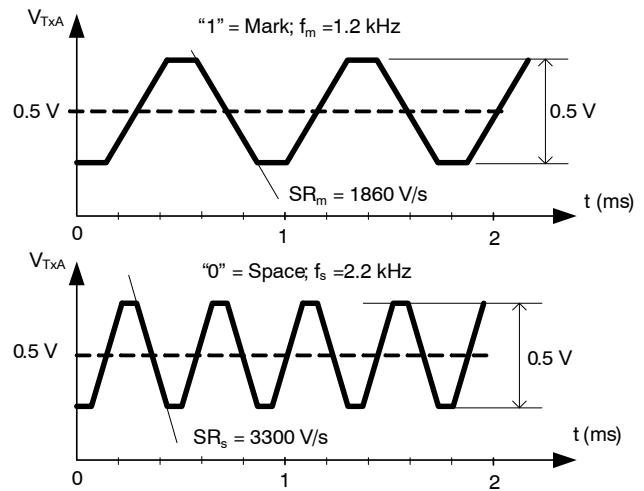


Figure 7. Modulator shaped output signal for Mark and Space frequency at TxA pin.

Demodulator

The demodulator accepts a FSK signal at the RxA input and reconstructs the original modulated signal at the RxD output. Figure 8 illustrates the demodulation process.

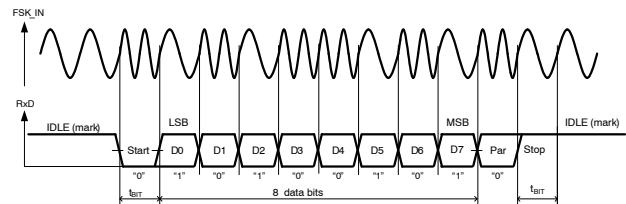


Figure 8. Modulation Timing

This HART bit stream follows a standard 11-bit UART frame with 1 startbit, 8 databits, 1 paritybit (odd) and 1 stopbit. The communication speed is 1200 baud.

Receive Filter and Comparator

The received FSK signal first is filtered using a band-pass filter build around the low noise receiver operational amplifier “Rx HP filter”. This filter blocks interferences outside the HART signal band.

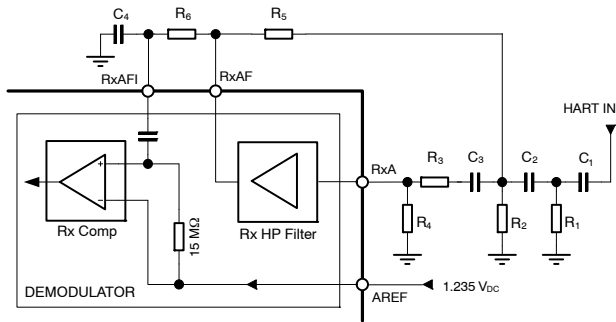


Figure 9. Demodulator Receive Filter and Signal Comparator

The filter output is fed into the Rx comparator. The threshold value equals the analog ground making the comparator to toggle on every zero crossing of the filtered FSK signal. The maximum demodulator jitter is 12% of one bit given the input frequencies are within the HART specifications, a clock frequency of 460.8 kHz ($\pm 1.0\%$) and zero input (RxA) asymmetry.

Carrier Detect Circuitry

Low HART input signal levels increases the risk for the generation of bit errors. Therefore the minimum signal amplitude is set to 80 – 120 mVpp. If the received signal is below this level the demodulator is disabled.

This level detection is done in the Carrier Detector. The output of the demodulator is qualified with the carrier detect signal (CD), therefore, only RxA signals large enough to be detected (100 mVp-p typically) by the carrier detect circuit produce received serial data at Rx.D.

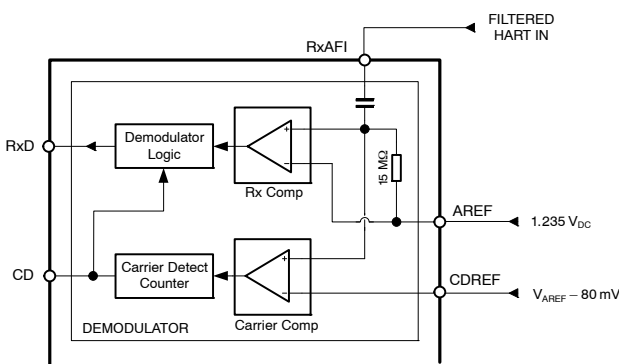


Figure 10. Demodulator Carrier and Signal Comparator

The carrier detect comparator shown in Figure 10 generates logic low output if the RxAFI voltage is below CDREF. The comparator output is fed into a carrier detect block. The carrier detect block drives the carrier detect

output pin CD high if RTSB is high and four consecutive pulses out of the comparator have arrived. CD stays high as long as RTSB is high and the next comparator pulse is received in less than 2.5 ms. Once CD goes inactive, it takes four consecutive pulses out of the comparator to assert CD again. Four consecutive pulses amount to 3.33 ms when the received signal is 1200 Hz and to 1.82 ms when the received signal is 2200 Hz.

MISCELLANEOUS ANALOG CIRCUITRY

Voltage References

The A5191HRT requires two voltage references, AREF and CDREF. AREF sets the DC operating point of the internal operational amplifiers and is the reference for the Rx comparator. If A5191HRT operates at $V_{DD} = 3.3$ V the **onsemi** LM285D 1.235 V reference is recommended.

The level at which CD (Carrier Detect) becomes active is determined by the DC voltage difference (CDREF – AREF). Selecting a voltage difference of 80 mV will set the carrier detect to a nominal 100 mV_{p-p}.

Bias Current Resistor

The A5191HRT requires a bias current resistor R_{BIAS} to be connected between CBIAS and V_{SS} . The bias current controls the operating parameters of the internal operational amplifiers and comparators and should be set to 2.5 μA .

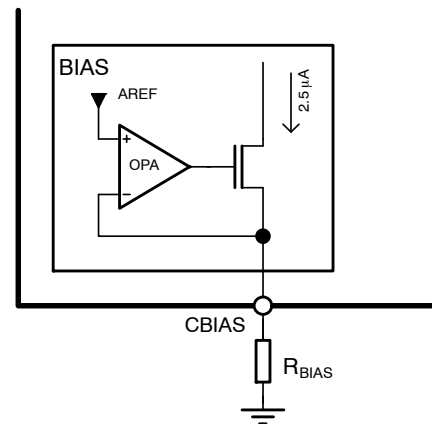


Figure 11. Bias Circuit

The value of the bias current resistor is determined by the reference voltage A_{REF} and the following formula:

$$R_{BIAS} = \frac{A_{REF}}{2.5 \mu A}$$

The recommended bias current resistor is 500 K Ω when AREF is equal to 1.235 V.

Oscillator

The A5191HRT requires a 460.8 kHz clock signal. This can be provided by an external clock or a resonator connected to the A5191HRT internal oscillator.

Internal Oscillator Option

The oscillator cell will function with either a 460.8 kHz crystal or ceramic resonator. A parallel resonant ceramic resonator can be connected between XIN and XOUT. Figure 12 illustrates the crystal option for clock generation using a 460.8 kHz ($\pm 1\%$ tolerance) parallel resonant crystal and two tuning capacitors C_x . The actual values of the capacitors may depend on the recommendations of the manufacturer of the resonator. Typically, capacitors in the range of 100 pF to 470 pF are used.

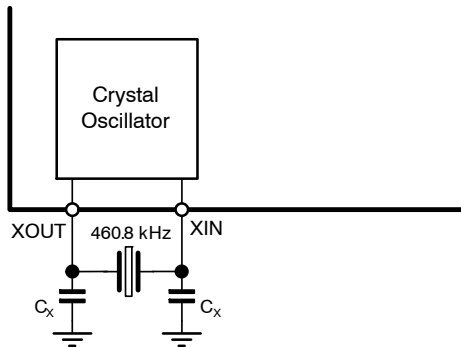


Figure 12. Crystal Oscillator

External Clock Option

It may be desirable to use an external 460.8 kHz clock as shown in Figure 13 rather than the internal oscillator. In addition, the A5191HRT consumes less current when an external clock is used. Minimum current consumption occurs with the clock connected to XOUT and XIN connected to V_{SS} .

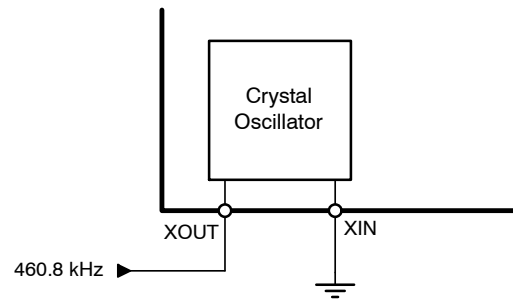


Figure 13. Oscillator with External Clock

Power On Reset

During start-up the RESETB pin should be kept low until the voltage level on V_{DD} is above the minimum level $V_{DDH} = 2.5$ V to guarantee correct operation of the digital circuitry. As illustrated in Figure 14 RESETB should be kept low for at least $t_{POR} = 10$ ns after this threshold level is reached.

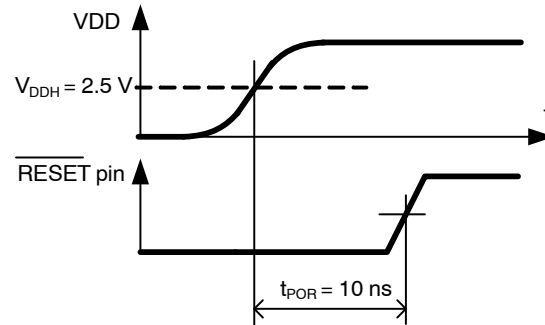


Figure 14. Power On Reset Timing

A5191HRT

Ordering Information

The A5191HRT is available in a 28-pin plastic leaded chip carrier (PLCC), 32-pin quad flat no-lead (QFN) and 32-pin low-profile quad flat pack (LQFP). Use the following part numbers when ordering. Contact your local sales representative for more information: www.onsemi.com.

Table 9. ORDERING INFORMATION

Part Number	Temperature Range	Package	Shipping Configuration [†]
A5191HRTLQ-XTP (Industrial)	–40 °C to +85 °C	32-pin LQFP Green / RoHS compliant	2500 / Tape & Reel
A5191HRTNG-XTP (Industrial)	–40 °C to +85 °C	32-pin QFN Green / RoHS compliant	5000 / Tape & Reel

DISCONTINUED (Note 5)

A5191HRTLQ-XTD (Industrial)	–40 °C to +85 °C	32-pin LQFP Green / RoHS compliant	250 Units / Tray
A5191HRTNG-XTD (Industrial)	–40 °C to +85 °C	32-pin QFN Green / RoHS compliant	60 Units / Tube/Tray
A5191HRTPG-XTD (Industrial)	–40 °C to +85 °C	28-pin PLCC Green / RoHS compliant	37 Units / Tube
A5191HRTPG-XTP (Industrial)	–40 °C to +85 °C	28-pin PLCC Green / RoHS compliant	750 / Tape & Reel

[†] For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

5. **DISCONTINUED:** These devices are not available. Please contact your **onsemi** representative for information. The most current information on these devices may be available on www.onsemi.com.



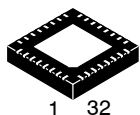
A5191HRT

REVISION HISTORY

Revision	Description of Changes	Date
12	A5191HRTPG-XTP OPN Marked as Discontinued.	1/14/2026

This document has undergone updates prior to the inclusion of this revision history table. The changes tracked here only reflect updates made on the noted approval dates.

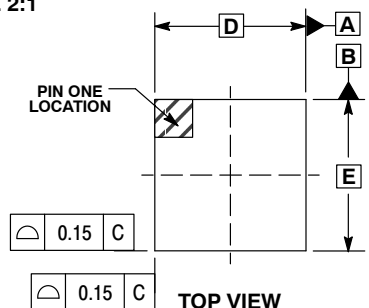




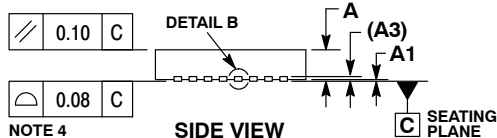
1 32
SCALE 2:1

QFN32 5x5, 0.5P
CASE 488AM
ISSUE A

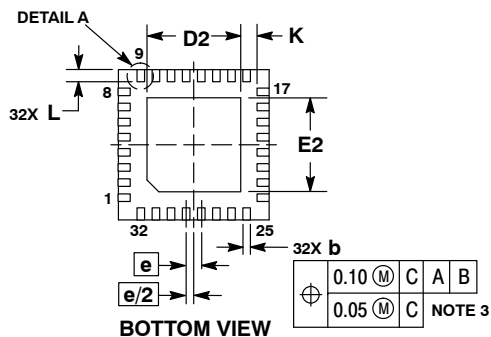
DATE 23 OCT 2013



TOP VIEW

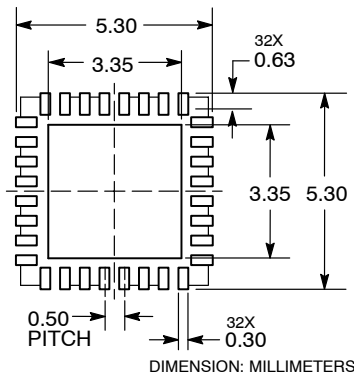


SIDE VIEW

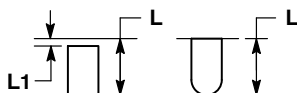


BOTTOM VIEW

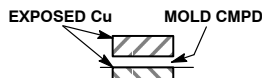
**RECOMMENDED
SOLDERING FOOTPRINT***



DIMENSION: MILLIMETERS



DETAIL A
ALTERNATE TERMINAL
CONSTRUCTIONS



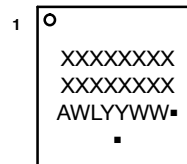
DETAIL B
ALTERNATE
CONSTRUCTION

NOTES:

1. DIMENSIONS AND TOLERANCING PER ASME Y14.5M, 1994.
2. CONTROLLING DIMENSION: MILLIMETERS.
3. DIMENSION b APPLIES TO PLATED TERMINAL AND IS MEASURED BETWEEN 0.15 AND 0.30MM FROM THE TERMINAL TIP.
4. COPLANARITY APPLIES TO THE EXPOSED PAD AS WELL AS THE TERMINALS.

MILLIMETERS		
DIM	MIN	MAX
A	0.80	1.00
A1		0.05
A3	0.20 REF	
b	0.18	0.30
D	5.00 BSC	
D2	2.95	3.25
E	5.00 BSC	
E2	2.95	3.25
e	0.50 BSC	
K	0.20	
L	0.30	0.50
L1		0.15

**GENERIC
MARKING DIAGRAM***



XXXXX = Specific Device Code
A = Assembly Location
WL = Wafer Lot
YY = Year
WW = Work Week
▪ = Pb-Free Package

(Note: Microdot may be in either location)

*This information is generic. Please refer to device data sheet for actual part marking.
Pb-Free indicator, "G" or microdot "▪", may or may not be present.

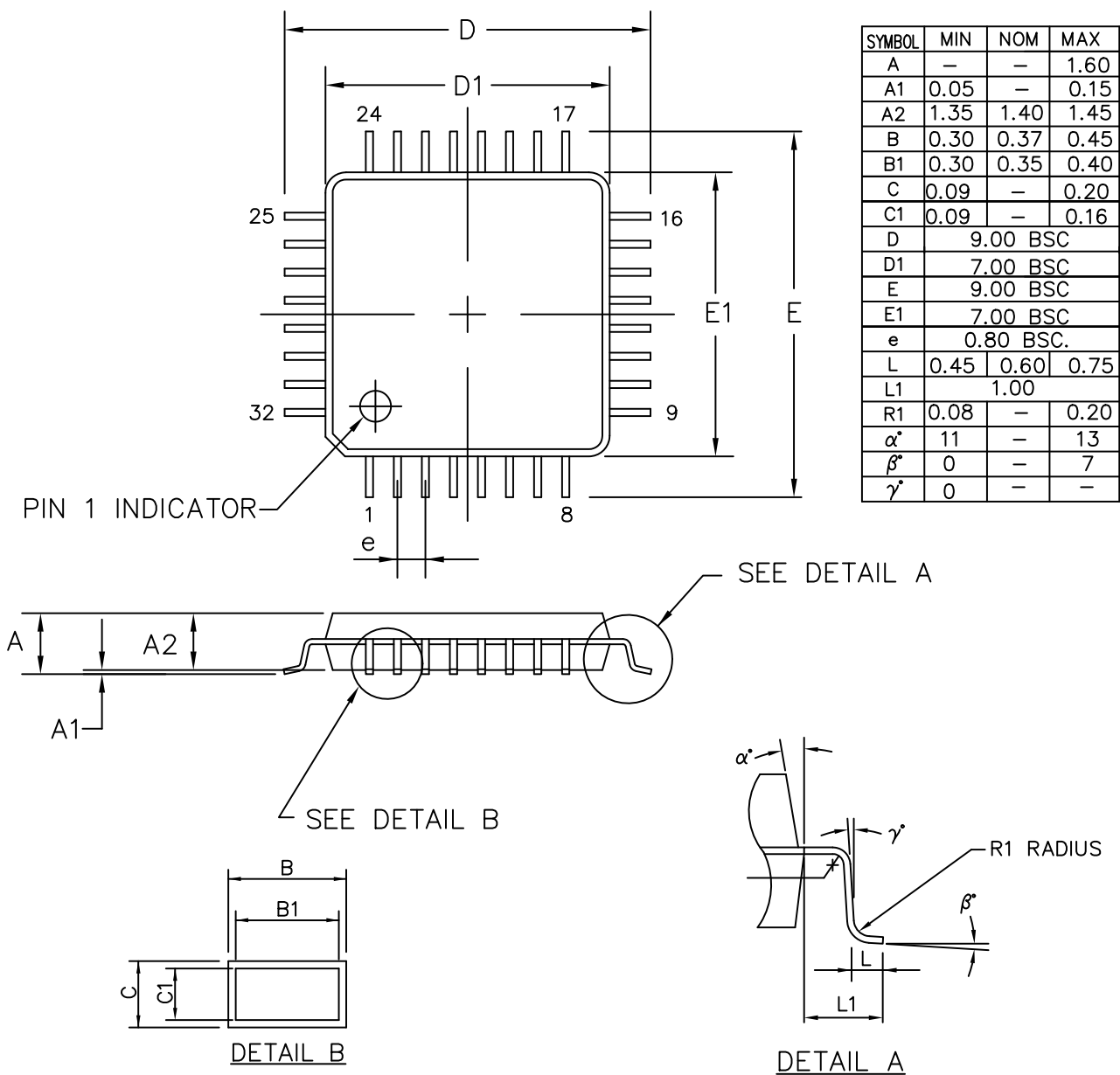
*For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

DOCUMENT NUMBER:	98AON20032D	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	QFN32 5x5 0.5P	PAGE 1 OF 1

onsemi and Onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

LQFP-32, 7x7
CASE 561AB
ISSUE O

DATE 19 JUN 2008



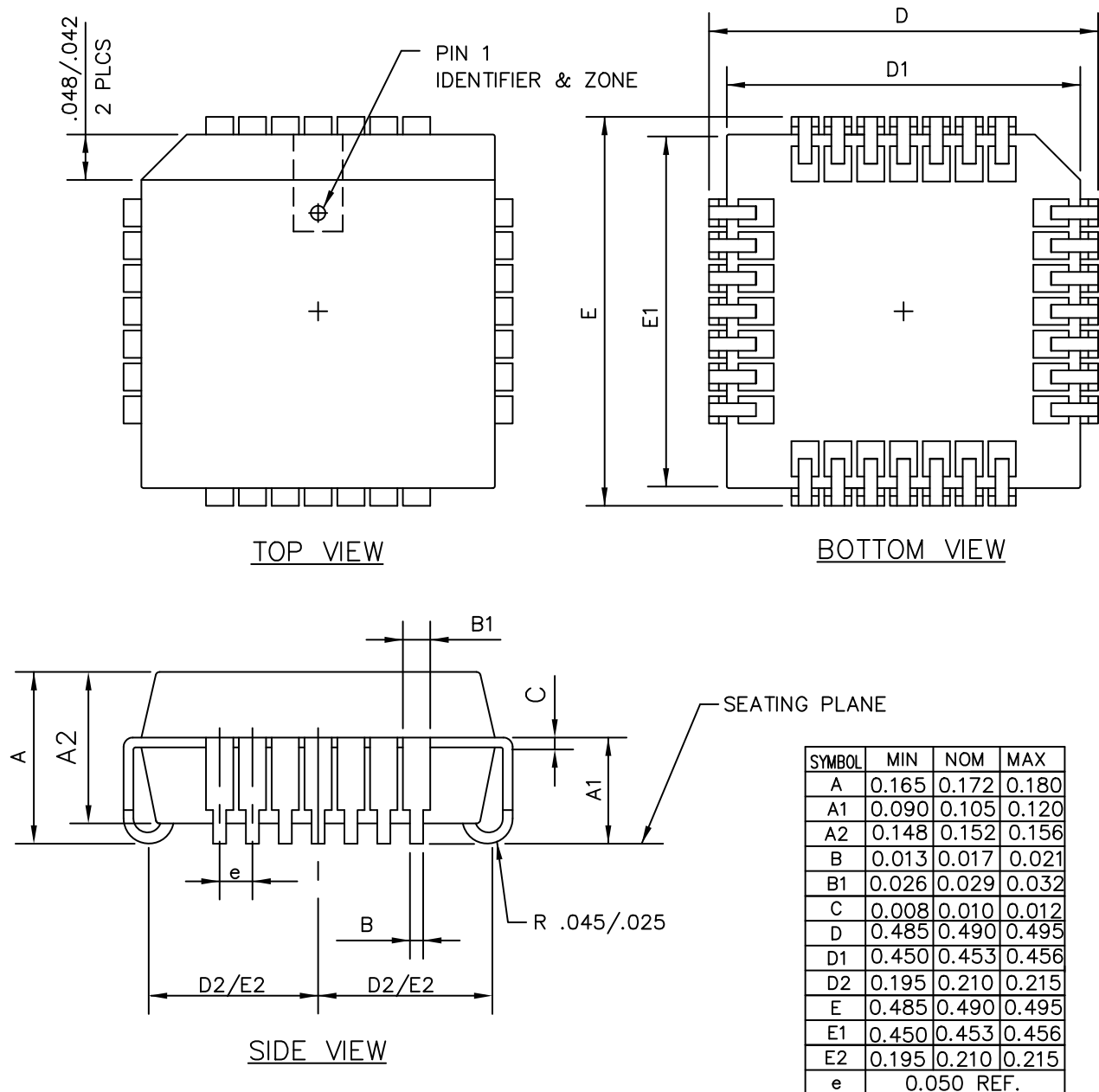
ALL DIMENSIONS IN MM

DOCUMENT NUMBER:	98AON30893E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	32 LEAD LQFP, 7X7	PAGE 1 OF 1

onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

PLCC 28 LEAD
CASE 776AA
ISSUE O

DATE 19 JUN 2008



ALL DIMENSIONS ARE IN INCHES.

DOCUMENT NUMBER:	98AON30890E	Electronic versions are uncontrolled except when accessed directly from the Document Repository. Printed versions are uncontrolled except when stamped "CONTROLLED COPY" in red.
DESCRIPTION:	PLCC 28 LEAD	PAGE 1 OF 1

onsemi and onsemi are trademarks of Semiconductor Components Industries, LLC dba onsemi or its subsidiaries in the United States and/or other countries. onsemi reserves the right to make changes without further notice to any products herein. onsemi makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. onsemi does not convey any license under its patent rights nor the rights of others.

onsemi, **Onsemi**, and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "**onsemi**" or its affiliates and/or subsidiaries in the United States and/or other countries. **onsemi** owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of **onsemi**'s product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. **onsemi** reserves the right to make changes at any time to any products or information herein, without notice. The information herein is provided "as-is" and **onsemi** makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does **onsemi** assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using **onsemi** products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by **onsemi**. "Typical" parameters which may be provided in **onsemi** data sheets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. **onsemi** does not convey any license under any of its intellectual property rights nor the rights of others. **onsemi** products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use **onsemi** products for any such unintended or unauthorized application, Buyer shall indemnify and hold **onsemi** and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that **onsemi** was negligent regarding the design or manufacture of the part. **onsemi** is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

ADDITIONAL INFORMATION

TECHNICAL PUBLICATIONS:

Technical Library: www.onsemi.com/design/resources/technical-documentation
onsemi Website: www.onsemi.com

ONLINE SUPPORT: www.onsemi.com/support

For additional information, please contact your local Sales Representative at
www.onsemi.com/support/sales